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| STN | Tavivá na mäkké spájkovanie Skúšobné metódy Časť 11: Rozpustnosť zvyškov taviva (ISO 9455-11: 2017) | STN EN ISO 9455-11 05 5707 |
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Soft soldering fluxes - Test methods - Part 11: Solubility of flux residues (ISO 9455-11:2017)

Táto norma obsahuje anglickú verziu európskej normy.
This standard includes the English version of the European Standard.

Táto norma bola oznámená vo Vestníku ÚNMS SR č. 03/18

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Soft soldering fluxes - Test methods - Part 11: Solubility of flux residues (ISO 9455-11:2017)

Flux de brasage tendre - Méthodes d'essai - Partie 11:
Solubilité des résidus de flux (ISO 9455-11:2017)

Flussmittel zum Weichlöten - Prüfverfahren - Teil 11:
Löslichkeit von Flussmittelrückständen (ISO 9455-
11:2017)

This European Standard was approved by CEN on 12 September 2017.

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EN ISO 9455-11:2017 (E)

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European foreword

This document (EN ISO 9455-11:2017) has been prepared by Technical Committee ISO/TC 44 “Welding and allied processes” in collaboration with Technical Committee CEN/TC 121 “Welding and allied processes” the secretariat of which is held by DIN.

This European Standard shall be given the status of a national standard, either by publication of an identical text or by endorsement, at the latest by March 2018, and conflicting national standards shall be withdrawn at the latest by March 2018.

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. CEN shall not be held responsible for identifying any or all such patent rights.

This document supersedes EN 29455-11:1993.

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Endorsement notice

The text of ISO 9455-11:2017 has been approved by CEN as EN ISO 9455-11:2017 without any modification.

INTERNATIONAL STANDARD

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Second edition
2017-08

Soft soldering fluxes — Test methods —

Part 11: Solubility of flux residues

*Flux de brasage tendre — Méthodes d'essai —
Partie 11: Solubilité des résidus de flux*



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ISO 9455-11:2017(E)**Foreword**

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular the different approval criteria needed for the different types of ISO documents should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see www.iso.org/directives).

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Any trade name used in this document is information given for the convenience of users and does not constitute an endorsement.

For an explanation on the voluntary nature of standards, the meaning of ISO specific terms and expressions related to conformity assessment, as well as information about ISO's adherence to the World Trade Organization (WTO) principles in the Technical Barriers to Trade (TBT) see the following URL: www.iso.org/iso/foreword.html.

This document was prepared by Technical Committee ISO/TC 44, *Welding and allied processes*, Subcommittee SC 12, *Soldering materials*.

This second edition cancels and replaces the first edition (ISO 9455-11:1991), which has been technically revised.

The main changes to the previous version are:

- thickness in [5.6.2 b](#)) has been clarified;
- alloy of the brass sheets has been clarified;
- the test procedure regarding immersion has been clarified;
- the test report has been updated;
- editorial revisions have been made.

A list of all parts in the ISO 9455 series can be found on the ISO website.

Requests for official interpretations of any aspect of this document should be directed to the Secretariat of ISO/TC 44/SC 12 via your national standards body. A complete listing of these bodies can be found at www.iso.org.

Soft soldering fluxes — Test methods —

Part 11: Solubility of flux residues

1 Scope

This document specifies a qualitative method for assessing the solubility of flux residues in a selected solvent. The method is applicable to all fluxes of Type 1, as defined in ISO 9454-1.

NOTE This test gives no assurance that post-cleaning residues, which may be present in sufficiently small amounts to pass the test, will not be detrimental to the soldered assembly in the long term.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO 9454-1, *Soft soldering fluxes — Classification and requirements — Part 1: Classification, labelling and packaging*

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